## 2SD2623G

## Silicon NPN epitaxial planar type

For low-frequency amplification

#### ■ Features

- Low ON resistance Ron
- S-Mini type package, allowing downsizing of the equipment and automatic insertion through the tape packing.

### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	25	V	
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	20	V	
Emitter-base voltage (Collector open)	$V_{EBO}$	12	V	
Collector current	$I_{C}$	0.5	A	
Peak collector current	$I_{CP}$	1	A	
Collector power dissipation	P <sub>C</sub>	150	mW	
Junction temperature	T <sub>j</sub>	150	°C	
Storage temperature	$T_{stg}$	-55 to +150	°C	

#### ■ Package

- Code SMini3-F2
- Marking Symbol: 2V
- Pin Name
  - 1: Base
- 2: Emitter
- 3: Collector

### ■ Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_C = 10 \mu\text{A}, I_E = 0$	25	J. J.		V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_C = 1 \text{ mA}, I_B = 0$	20	0		V
Emitter-base voltage (Collector open)	$V_{\rm EBO}$	$I_E = 10  \mu A, I_C = 0$	12			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 25 \text{ V}, I_{E} = 0$	0		100	nA
Forward current transfer ratio *1,2	h <sub>FE</sub>	$V_{CE} = 2 \text{ V}, I_{C} = 0.5 \text{ A}$	200		800	
Collector-emitter saturation voltage *1	V <sub>CE(sat)</sub>	$I_C = 0.5 \text{ A}, I_B = 20 \text{ mA}$		0.14	0.40	V
Base-emitter saturation voltage *1	V <sub>BE(sat)</sub>	$I_C = 0.5 \text{ A}, I_B = 50 \text{ mA}$			1.2	V
Transition frequency	$f_T$	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		10		pF
ON resistanse *3	R <sub>on</sub>	-CO		1.0		Ω

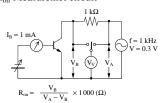
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

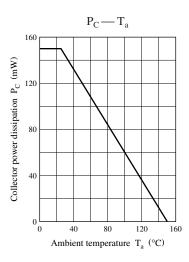
#### 2. \*1: Pulse measurement

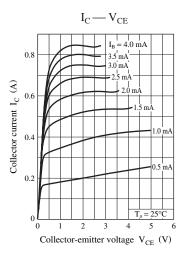
\*2: Rank classification

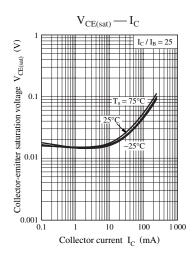
Rank	R	S	Т
$h_{FE}$	200 to 350	300 to 500	400 to 800

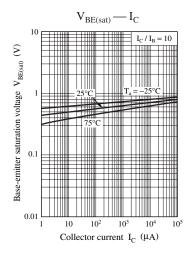
\*3: R<sub>on</sub> Measuremet circuit

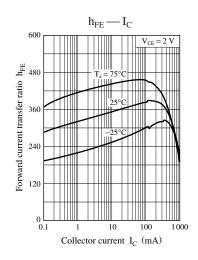


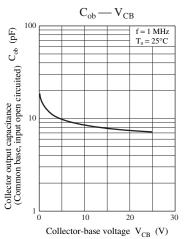






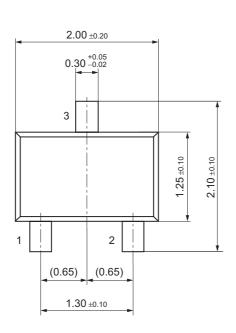


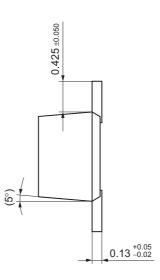




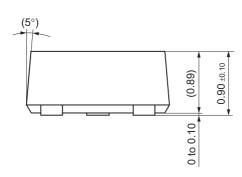
2 SJC00378AED

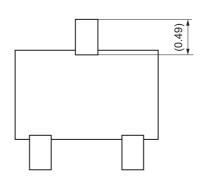
SMini3-F2 Unit: mm











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